

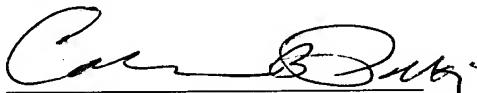
**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**APPLICANT:** Robert E. Stewart      **EXAMINER:** Whitmore, Stacy  
**SERIAL NO.:** 10/106,156      **GROUP:** 2812  
**FILED:** 03/26/2002      **DOCKET:** LIT-113/GCD 01-07  
**TITLE:** FIELD-ASSISTED FUSION BONDING

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**CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the U.S. Postal Service as first class mail in an envelope addressed to: Mail Stop Commissioner for Patents, P.O. Box 1450, Arlington, VA 22313-1450 on July 30, 2003.



Carmen B. Patti  
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Reg. No. 26,784

Date of Signature: July 30, 2003

Mail Stop Commissioner for Patents  
P.O. Box 1450  
Arlington, VA 22313-1450

**PRELIMINARY AMENDMENT**  
**REQUEST FOR THE PROSECUTION OF A DIVISIONAL APPLICATION**

Dear Sir:

Claims 1-8, drawn to a process of bonding multiple layers of a semiconductor, classified in class 438, subclass 470, were elected in a restriction.

The applicant wishes to proceed with the prosecution of the non-elected claims namely claims 19-29, drawn to an apparatus for bonding and heating, classified in class 219, subclass 635. Claims 1-18 are herewith cancelled in this divisional application.